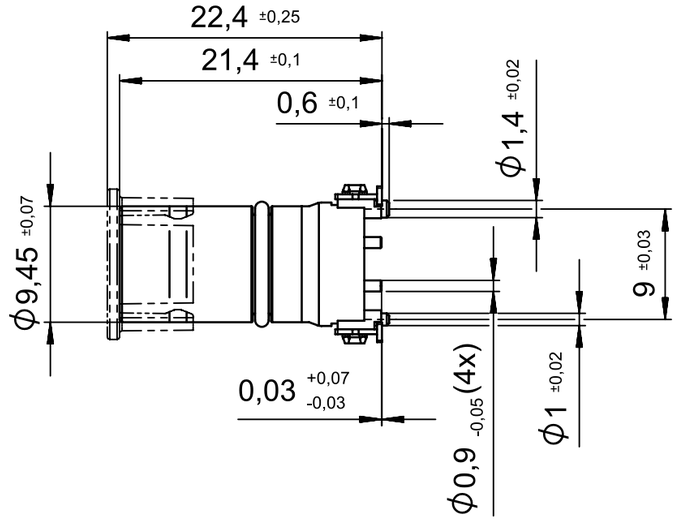
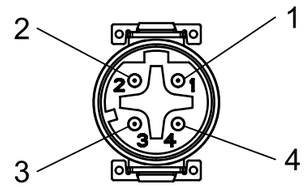
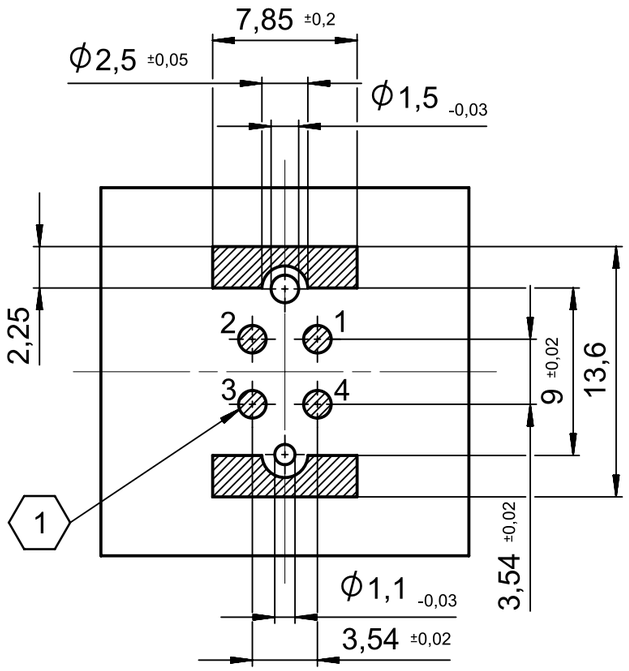




plug face male



PCB-layout (advice)



3:1

Coplanarity of all contacts and anchor plate | 0.1

Recommended solder paste thickness 150µm

(1) Further information on soldering process and recommended layout, see brochure "Connectors for SMT production"

- EN ISO 291 23/50

DIN A3	document-no. / ri: 102983926 / 00	article-no. / ri: 1411942 / 04	scale: 2:1
PHOENIX CONTACT	date: 2025-10-29	document-type: TECDOC 2D-Productdrawing	- Simplified representation - Linear dimensions (mm)
page 1 of 1	description: SACC-CIP-M12MSD-4P SMD T		

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